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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/591,516	08/08/2007	Hirokazu Arai	58328/A400	1668
	7590 07/25/201 RKER & HALE, LLP	EXAMINER		
PO BOX 7068		LACLAIR, DARCY D		
PASADENA, CA 91109-7068			ART UNIT	PAPER NUMBER
			1763	
			MAIL DATE	DELIVERY MODE
			07/25/2011	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)		
	10/591,516	ARAI ET AL.		
Office Action Summary	Examiner	Art Unit		
	DARCY D. LACLAIR	1763		
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	correspondence address		
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 16(a). In no event, however, may a reply be tim ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).		
Status				
 1) Responsive to communication(s) filed on 12 Ma 2a) This action is FINAL. 2b) This 3) Since this application is in condition for allowant closed in accordance with the practice under E 	action is non-final. ace except for formal matters, pro			
Disposition of Claims				
4) ☐ Claim(s) 1-5 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-5 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or				
Application Papers				
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction of the original transfer of the second sheet (s) including the correction of the original transfer of the second sheet (s) including the correction of the second sheet (s) including the secon	epted or b) objected to by the Idrawing(s) be held in abeyance. See on is required if the drawing(s) is object.	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 				
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal F 6) Other:	ate		

DETAILED ACTION

1. All outstanding rejections, except for those maintained below are withdrawn in light of the amendment filed on 5/12/2011.

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Upon reconsideration of the claims and an updated search, new grounds of rejection are set forth below which were are not necessitated by applicant's amendment. Thus, a 2nd non-final Office action is set forth as follows.

Double Patenting

2. Claims 1-5 are rejected on the ground of nonstatutory obviousness-type double patenting as being unpatentable over claims 1-8 of U.S. Patent No. 6,716,907 in view of Togashi et al. (US 5,064,881) and Amagai et al. (US 20030130438). Although the conflicting claims are not identical, they are not patentably distinct from each other because both require a resol based phenolic molding composition.

With regard to Claims 1 and 3, the conflicting patent requires a resol based phenolic resin composition comprising, per 100 parts of resin by weight, 40 to 100 parts by weight of inorganic fiber, 20 to 90 parts of a natural silica, and 1 to 15 parts of a rubber component. (Claim 1) Further, the conflicting patent requires that the natural silica powder is shaped like pulverized power. (Claim 3) The conflicting patent does

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not explicitly teach the use of a silica having a particle size of 0.5 to 15 microns. Togashi teaches an epoxy resin containing a phenol type resin, having a specific pulverized silica particle which has reduced mold shrinkage and improved precision in molding. (Abstract) The silica used to reduce mold shrinkage and improve molding is a specific pulverized silica (see col 2 line 20) having an average particle size up to 8 microns, and a maximum particle size up to 60 microns, (see col 2 line 50-51) and a specific pulverized silica having a maximum particle size of 10 microns, and an average particle size of 1.8 microns is exemplified. (See col 9 line 51-52) This silica allows high filling while simultaneously maintaining flowability. (See col 4 line 32-50) Furthermore, surface roughness of the molded objects is reduced, along with reduced mold shrinkage. (See col 7 line 54-60) This silica is used in a composition further including a glass fiber. (See col 2 line 40) The conflicting patent teaches a silane coupling agent in order to improve the adhesion of the glass fiber filler to the phenolic resin, (see col 2 line 57) and Togashi teaches that a coupling agent such as γ -glycidoxypropyltrimethoxysilane can be added to the composition (see col 9 line 23-24) but neither explicitly teaches treating the silica powder with this agent. Amagai teaches that silicas such as natural silica and glass (see par [0110] can be used in a phenol resin composition (see par [0086]) and that these benefit from surface treatment with a coupling agent such as γ -glycidoxypropyltrimethoxysilane and the like to improve conformability. (See par [0141]) It would be obvious to one of ordinary skill in the art to use the coupling agents taught by both the conflicting patent and Togashi in the manner described by Amagai in order to improve the adhesion of the silica filler to the phenol

resin. Based on the similarities in the compositions, both including a phenol resin and glass fibers, it would be obvious to one of ordinary skill in the art to use a coupling agent treated small pulverized silica having a reduced particle size as a replacement for the conflicting patent's slightly larger silica in order to obtain good flowability and therefore good mold filling and reduced molding flaws, a reduced surface roughness, and a reduced mold shrinkage, which further results in reduced warping or misshaping of the molded article due to the shrinkage, as similar benefits would be expected.

With respect to Claim 2, attention is first directed at the discussion of Claim 1, above. The conflicting patent further requires that the inorganic fiber includes 50% or more by weight of glass fiber. (Claim 2)

With respect to Claim 4, attention is directed at the discussion of Claims 1-3, above.

With respect to Claim 5, the conflicting patent requires that the resin is prepared in the form of a resin pulley molded from the composition. (Claim 5-8)

Claim Rejections - 35 USC § 103

3. Claims 1-5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Asai et al. (US 2002/0123557) in view of Togashi et al. (US 5,064,881) and Amagai et al. (US 20030130438).

With regard to Claims 1 and 3, Asai teaches a resol based phenolic resin composition containing, per 100 parts of resin by weight, 40 to 100 parts by weight of inorganic fiber, 20 to 90 parts of a natural silica, and 1 to 15 parts of a rubber

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component. The natural silica powder is preferably shaped like pulverized power. (See abstract).

Asai does not explicitly teach the use of a silica having a particle size of 0.5 to 15 microns.

Togashi teaches an epoxy resin containing a phenol type resin, having a specific pulverized silica particle which has reduced mold shrinkage and improved precision in molding. (Abstract) The silica used to reduce mold shrinkage and improve molding is a specific pulverized silica (see col 2 line 20) having an average particle size up to 8 microns, and a maximum particle size up to 60 microns, (see col 2 line 50-51) and a specific pulverized silica having a maximum particle size of 10 microns, and an average particle size of 1.8 microns is exemplified. (See col 9 line 51-52) This silica allows high filling while simultaneously maintaining flowability. (See col 4 line 32-50) Furthermore, surface roughness of the molded objects is reduced, along with reduced mold shrinkage. (See col 7 line 54-60) This silica is used in a composition further including a glass fiber. (See col 2 line 40) The conflicting patent teaches a silane coupling agent in order to improve the adhesion of the glass fiber filler to the phenolic resin, (see col 2 line 57) and Togashi teaches that a coupling agent such as γ -glycidoxypropyltrimethoxysilane can be added to the composition (see col 9 line 23-24) but neither explicitly teaches treating the silica powder with this agent. Amagai teaches that silicas such as natural silica and glass (see par [0110] can be used in a phenol resin composition (see par [0086]) and that these benefit from surface treatment with a coupling agent such as γ -glycidoxypropyltrimethoxysilane and the like to improve

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conformability. (See par [0141]) It would be obvious to one of ordinary skill in the art to use the coupling agents taught by both the conflicting patent and Togashi in the manner described by Amagai in order to improve the adhesion of the silica filler to the phenol resin. Based on the similarities in the compositions, both including a phenol resin and glass fibers, it would be obvious to one of ordinary skill in the art to use a coupling agent treated small pulverized silica having a reduced particle size as a replacement for the conflicting patent's slightly larger silica in order to obtain good flowability and therefore good mold filling and reduced molding flaws, a reduced surface roughness, and a reduced mold shrinkage, which further results in reduced warping or misshaping of the molded article due to the shrinkage, as similar benefits would be expected.

With respect to Claim 2, attention is first directed at the discussion of Claim 1, above. Asai teaches that it is preferred that the inorganic fiber includes 50% or more by weight of glass fiber. (See abstract)

With respect to Claim 4, attention is directed at the discussion of Claims 1-3, above.

With respect to Claim 5, Asai teaches that the resin is prepared in the form of a resin pulley molded from the composition. (See abstract)

Response to Arguments

4. Applicant's arguments filed **5/12/2011** have been fully considered. Specifically, applicant argues

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(A) The obviousness type double patenting rejection and the 103 rejection set forth in the office action neither teach nor suggest a natural silica powder which has been *subjected to a coupling agent treatment*. This treatment provides improved adhesion of the silica powder to the phenol resin and prevents loss of silica powder due to frictional resistance.

5. **With respect to argument (A),** applicant's arguments have been considered, but are most in view of the rejection set forth above.

Conclusion

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Darcy D. LaClair whose telephone number is (571)270-5462. The examiner can normally be reached on Monday-Friday 8:30-6.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Milton Cano can be reached on 571-272-1398. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/MILTON I CANO/ Supervisory Patent Examiner, Art Unit 1763 Darcy D. LaClair Examiner Art Unit 1763

/DDL/